

ENGINEERING

DEPT.

## PRODUCT SPECIFICATION For CJ04 Series Board Mount Telephone Jacks

SPEC.NO.: SPCJ006E

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1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

MIL - STD - 202Methods for test of connectors for electronic equipmentMIL - STD - 1344Test methods for electrical connectors

- 3. APPLICABLE SERIES NO.: CJ04 Series
- 4. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings
- 5. MATERIALS See attached drawings
- 6. ACCOMMODATED P.C.BOARD6.1 Thickness: 1.6 mm (.063")6.2 P.C. Board Layout: See attached drawings



REVIEWED : <u>Alex</u> APPROVED : <u>David</u> VERIFIED : <u>Sandy</u>.



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### 7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		1.5A 125V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max. 100 mA max.	Less than 20 m $\Omega$
7.3	Dielectric strength	When applied AC 1000 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 500 M $\Omega$

#### 8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Mating force	Measure force to mate samples at speed 25±3mm per minute with plug latch depressed	2.27 Kgf (5 lb) max.
8.2	Retention force (Between the jack and plug)	Retention speed 25±3mm per minute from jack	7.7 Kgf (17 lb) min.
8.3	Durability	Connector shall be subjected to 300 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial

### 9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Vibration	1.5 mm 10 - 55 - 10 HZ/minute each 2 hours for X,Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.2	Solder ability	Soldering time: 5±0.5 second Soldering pot: 230± 5°C	Minimum: 90% of immersed area
9.3	Resistance to soldering heat	Soldering time: 5±0.5 second Soldering pot: 260±5°C	No damage
9.4	Heat aging	105±2°C, 96 hours	No damage
9.5	Humidity	40±2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3



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	ITEM	TEST CONDITION	REQUIREMENT
9.6	Temperature cycling	One cycle consists of : (1) $-55 {}^{+0}_{-3} \circ C$ , 30 min. (2)Room temp. 10-15 min. (3) $85 {}^{+3}_{-0} \circ C$ , 30 min. (4)Room temp. 10-15 min.	Appearance: No damage Contact resistance: Less than twice of initial
9.7	Salt spray	Temperature: 35±3°C Solution: 5±1% Spray time: 48±4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

10. AMBIENT TEMPERATURE RANGE: -40 to + 105°C